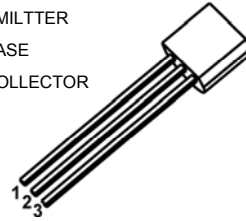


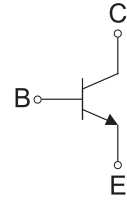
### Features

- NPN silicon epitaxial planar transistor for switching and Amplifier applications

1. EMILTTER
2. BASE
3. COLLECTOR



TO-92



Schematic Diagram

### Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	60	V
Collector-Emitter Voltage	V <sub>CEO</sub>	40	V
Emitter-Base Voltage	V <sub>EBO</sub>	6	V
Collector Current-Continuous	I <sub>C</sub>	0.2	A
Collector Power Dissipation	P <sub>C</sub>	0.625	W
Operation Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

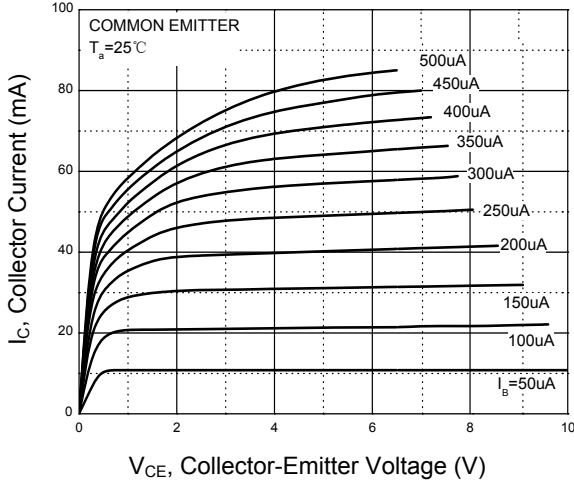
### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Max	Unit
Collector-Base Breakdown Voltage	V <sub>(BR)CBO</sub>	I <sub>C</sub> =10mA, I <sub>E</sub> =0	60	-	V
Collector-Emitter Breakdown Voltage	V <sub>(BR)CEO</sub>	I <sub>C</sub> =1mA, I <sub>B</sub> =0	40	-	V
Emitter-Base Breakdown Voltage	V <sub>(BR)EBO</sub>	I <sub>E</sub> =10mA, I <sub>C</sub> =0	6	-	V
Collector Cut-Off Current	I <sub>CBO</sub>	V <sub>CB</sub> =60V, I <sub>E</sub> =0	-	0.1	μA
Collector Cut-Off Current	I <sub>CEX</sub>	V <sub>CE</sub> =30V, V <sub>EB(off)</sub> =3V	-	0.05	μA
Emitter Cut-Off Current	I <sub>EBO</sub>	V <sub>EB</sub> =5V, I <sub>C</sub> =0	-	0.1	μA
DC Current Gain	h <sub>FE1</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =10mA	100	400	-
	h <sub>FE2</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =50mA	60	-	
	h <sub>FE3</sub>	V <sub>CE</sub> =1V, I <sub>C</sub> =100mA	30	-	
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =50mA, I <sub>B</sub> =5mA	-	0.3	V
Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =50mA, I <sub>B</sub> =5mA	-	0.95	V
Transition Frequency	f <sub>T</sub>	V <sub>CE</sub> =20V, I <sub>C</sub> =10mA, F=100MHz	300	-	MHz
Delay Time	t <sub>d</sub>	V <sub>CC</sub> =3V, V <sub>BE</sub> =0.5V, I <sub>C</sub> =10mA, I <sub>B1</sub> =1mA	-	35	ns
Rise Time	t <sub>r</sub>		-	35	ns
Storage Time	t <sub>s</sub>	V <sub>CC</sub> =3V, I <sub>C</sub> =10mA I <sub>B1</sub> =I <sub>B2</sub> =1mA	-	200	ns
Fall Time	t <sub>f</sub>		-	50	ns

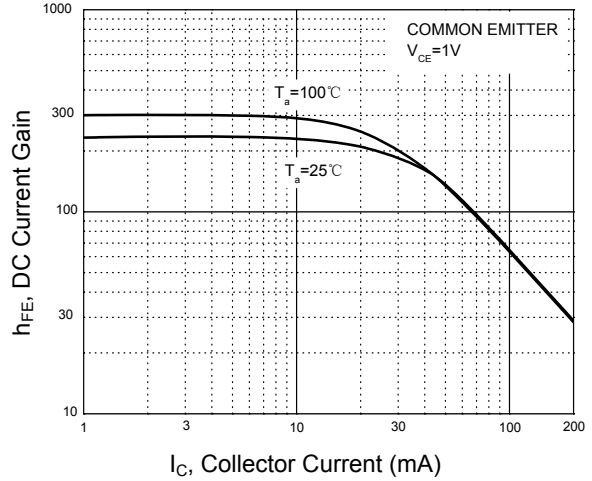
### Classification of h<sub>FE1</sub>

Rank	O	Y	G
Range	100-200	200-300	300-400

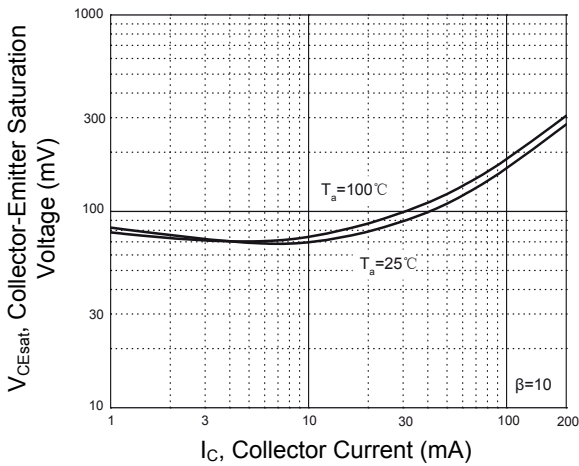
**Typical Characteristic Curves**



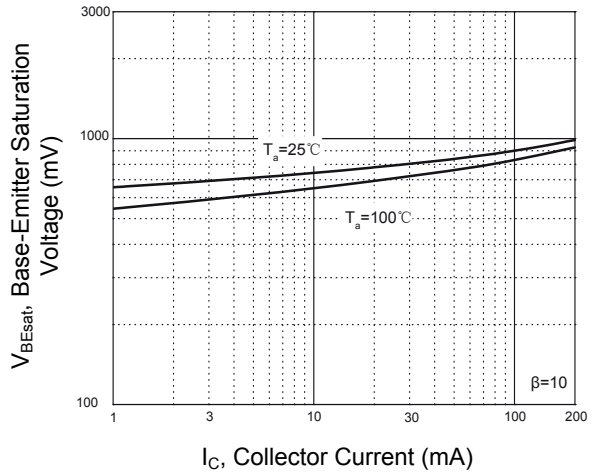
**Figure 1. Static Characteristic**



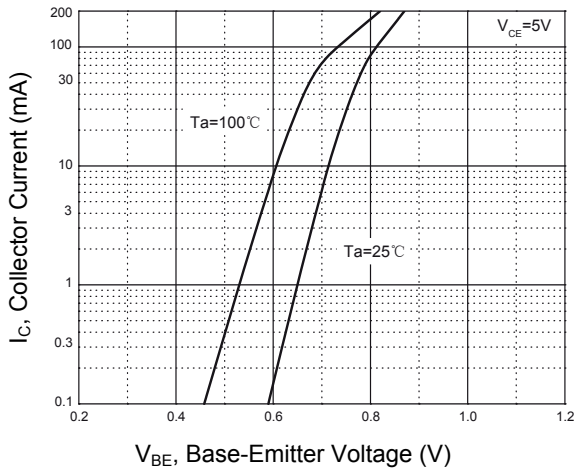
**Figure 2.  $h_{FE} - I_C$**



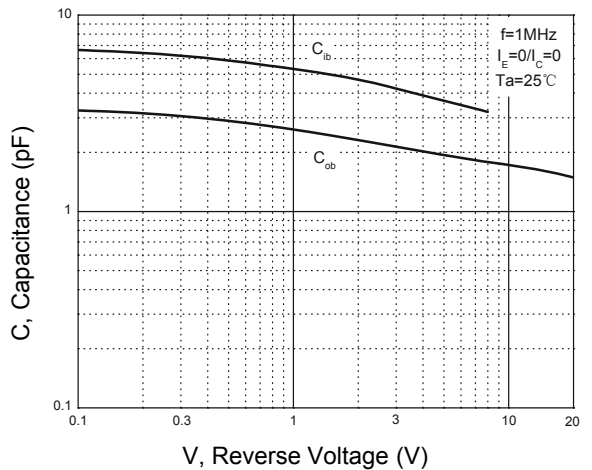
**Figure 3.  $V_{CEsat} - I_C$**



**Figure 4.  $V_{BEsat} - I_C$**

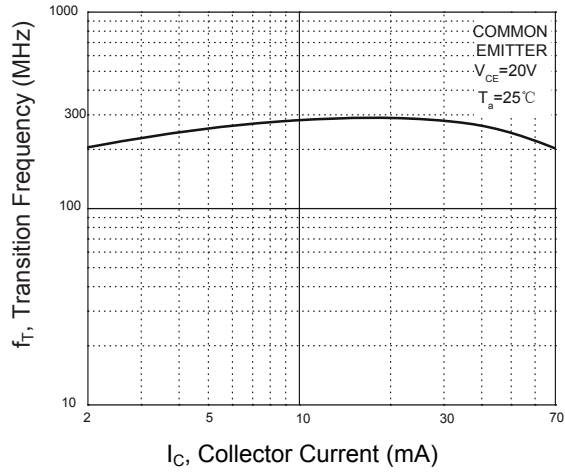


**Figure 5.  $I_C - V_{BE}$**

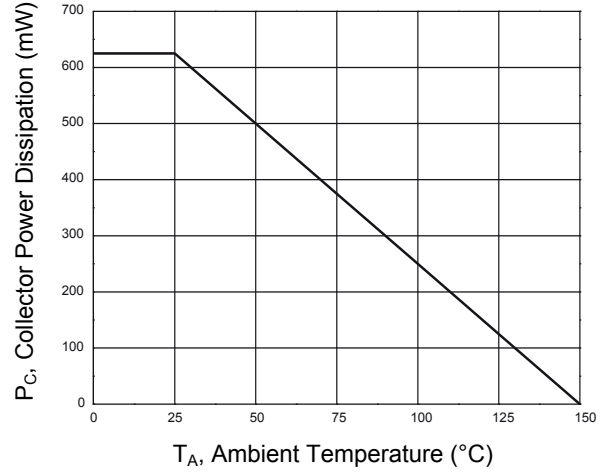


**Figure 6.  $C_{ob}/C_{ib} - V_{CB}/V_{EB}$**

**Typical Characteristic Curves**

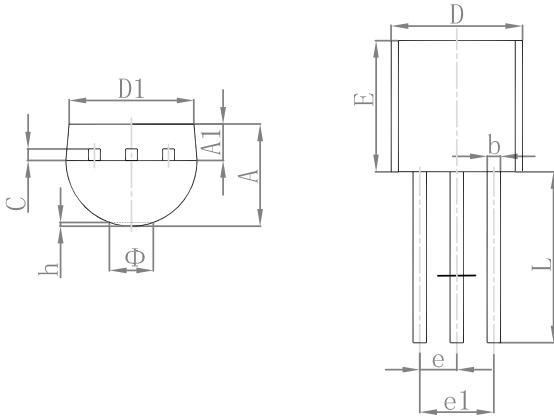


**Figure 7.  $f_T - I_C$**



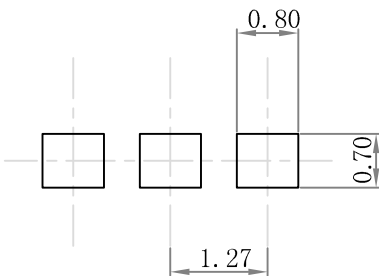
**Figure 8.  $P_C - T_a$**

**Package Outline Dimensions (TO-92)**



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	3.300	3.700	0.130	0.146
A1	1.100	1.400	0.043	0.055
b	0.380	0.550	0.015	0.022
c	0.360	0.510	0.014	0.020
D	4.300	4.700	0.169	0.185
D1	3.430	-	0.135	-
E	4.300	4.700	0.169	0.185
e	1.270 TYP		0.050 TYP	
e1	2.440	2.640	0.096	0.104
L	14.100	14.500	0.555	0.571
Φ	-	1.600	-	0.063
h	0.000	0.380	0.000	0.015

**Recommended Pad Layout**



**Note:**

1. Controlling dimension: in millimeters
2. General tolerance:  $\pm 0.05\text{mm}$
3. The pad layout is for reference purposes only

**Order Information**

Device	Package	Marking	Quantity	HSF Status
2N3904	TO-92	2N3904	2,000pcs / Box	RoHS Compliant